

Super Junction MOSFET

N-Channel Super Junction MOSFET

Features

• Drain-Source voltage: V_{DS}=750V (@T_J=150°C)

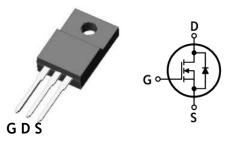
• Low drain-source On resistance: $R_{DS(on)}$ =0.6 Ω (Max.)

• Ultra low gate charge: Qg=13.5nC(Typ.)

RoHS compliant device100% avalanche tested

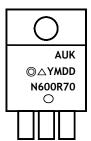
Ordering Information

| Part Number | Marking | Package | | |
|-------------|---------|------------|--|--|
| SJMN600R70F | N600R70 | TO-220F-3L | | |



TO-220F-3L

Marking Information



Column 1: Manufacturer

Column 2: Production Information

e.g.) ⊚△YMDD

-. YMDD: Date Code (Year, Month, Daily)

Column 3: Device Code

Absolute maximum ratings (T_C=25°C unless otherwise noted)

| Characteristic | | Symbol | Rating | Unit | |
|---|----------------|-----------------------|---------|------|--|
| Drain-source voltage | | V _{DSS} 700 | | ٧ | |
| Gate-source voltage | | V _{GSS} ±30 | | ٧ | |
| Drain gurrent (DC) (Note 1) | I _D | T _c =25°C | 7 | Α | |
| Drain current (DC) (Note 1) | | T _c =100°C | 4.4 | Α | |
| Drain current (Pulsed) (Note 1) | | I _{DM} | 28 | A | |
| Single pulsed avalanche energy (Note 2) | | E _{AS} | 158 | mJ | |
| Repetitive avalanche current (Note 1) | | I _{AR} 7 | | A | |
| Repetitive avalanche energy (Note 1) | | E _{AR} 3.2 | | mJ | |
| Power dissipation | | P_D | 32 | W | |
| Junction temperature | | TJ | 150 | °C | |
| Storage temperature range | | T_{stg} | -55~150 | °C | |

^{*} Limited only maximum junction temperature

Thermal Characteristics

| Characteristic | Symbol | Rating | Unit |
|---|---------------|-----------|------|
| Thermal resistance, junction to case | $R_{th(j-c)}$ | Max. 3.9 | °C/W |
| Thermal resistance, junction to ambient | $R_{th(j-a)}$ | Max. 62.5 | C/W |

Electrical Characteristics (T_C=25°C unless otherwise noted)

| Characteristic | Symbol | Test Condition | Min. | Тур. | Max. | Unit |
|--------------------------------|---------------------|--|------|------|------|------|
| Drain-source breakdown voltage | BV _{DSS} | BV_{DSS} $I_D=250uA, V_{GS}=0$ | | - | - | ٧ |
| Gate threshold voltage | $V_{GS(th)}$ | $V_{GS(th)}$ $I_D=250uA$, $V_{DS}=V_{GS}$ | | 3 | 4 | ٧ |
| Drain source out off current | | V _{DS} =700V, V _{GS} =0V | - | - | 1 | uA |
| Drain-source cut-off current | I _{DSS} | V _{DS} =700V, T _J =125°C | - | - | 100 | uA |
| Gate leakage current | I _{GSS} | V_{DS} =0V, V_{GS} =±30V | - | - | ±100 | nA |
| Drain-source on-resistance | R _{DS(ON)} | V _{GS} =10V, I _D =3.5A | - | - | 0.6 | Ω |
| Input capacitance | C _{iss} | | - | 557 | - | pF |
| Output capacitance | C _{oss} | $V_{DS}=25V$, $V_{GS}=0V$, $V_{SS}=0V$ | - | 294 | - | |
| Reverse transfer capacitance | C _{rss} | | - | 17 | - | |
| Turn-on delay time (Note 3) | t _{d(on)} | | - | 16 | - | |
| Rise time (Note 3) | t _r | V_{DS} =350V, I_{D} =7A, | - | 13 | - | |
| Turn-off delay time (Note 3) | t _{d(off)} | $R_G=25\Omega$ | - | 35 | - | ns |
| Fall time (Note 3) | t _f | | - | 7 | - | |
| Total gate charge (Note 4) | Qg | | - | 13.5 | - | |
| Gate-source charge (Note 4) | Q_{gs} | V_{DS} =400V, V_{GS} =10V, I_{D} =7A | - | 4.5 | - | nC |
| Gate-drain charge (Note 4) | Q_{gd} | | - | 3.5 | - | |

Source-Drain Diode Ratings and Characteristics (T_C=25°C unless otherwise noted)

| Characteristic Symbol Test Condition | | Min. | Тур. | Max. | Unit | |
|--------------------------------------|-----------------|--|------|------|------|----|
| Source current (DC) | I _S | Integral reverse diode | - | - | 7 | Α |
| Source current (Pulsed) | I _{SM} | in the MOSFET | - | - | 28 | Α |
| Forward voltage | V_{SD} | V_{GS} =0V, I_S =7A | - | - | 1.2 | ٧ |
| Reverse recovery time (Note 3,4) | t _{rr} | I _S =7A, V _{GS} =0V, | - | 278 | - | ns |
| Reverse recovery charge (Note 3,4) | Q_{rr} | dl _s /dt=100A/us | - | 2 | - | uC |

Note:

- 1. Calculated continuous current based on maximum allowable junction temperature
- 2. L=7mH, I_{AS} =7A, V_{DD} =50V, Starting T_J =25°C
- 3. Guaranteed by design, not subject to production testing
- 4. Pulse test: Pulse width≤300us, Duty cycle≤2%

Typical Electrical Characteristics Curves

Fig. 1 Typical Output Characteristics

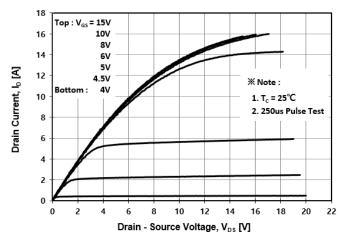


Fig. 2 Typical Transfer Characteristics

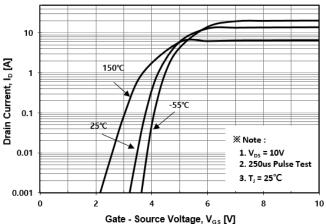


Fig.3 On-Resistance Variation with Drain Current and Gate Voltage

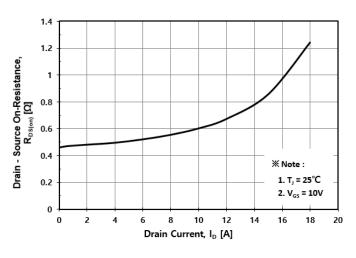


Fig. 4 Body Diode Forward Voltage Variation with Source Current

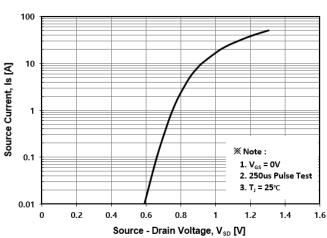


Fig. 5 Typical Capacitance Characteristics

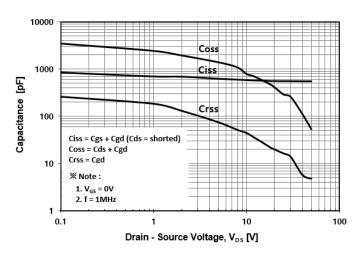


Fig. 6 Typical Total Gate Charge Characteristics

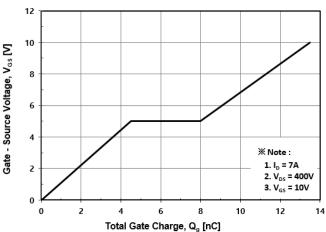


Fig. 7 Breakdown Voltage Variation vs. Temperature

Fig. 8 On-Resistance Variation vs. Temperature

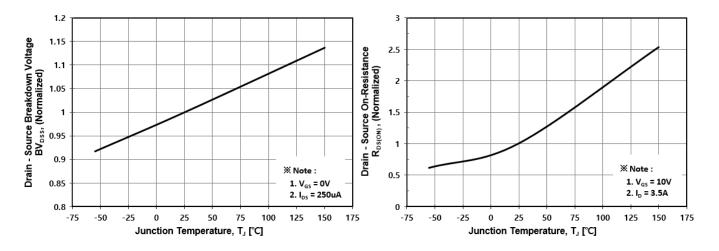


Fig. 9 Maximum Drain Current vs. Case Temperature

Fig. 10 Maximum Safe Operating Area

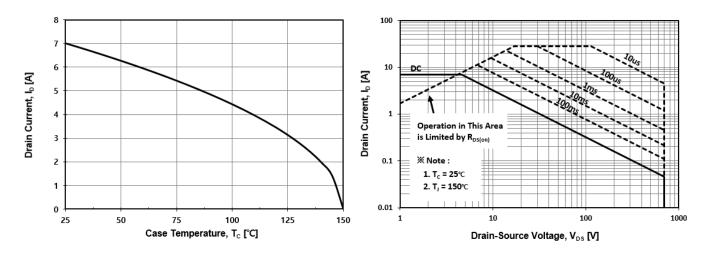
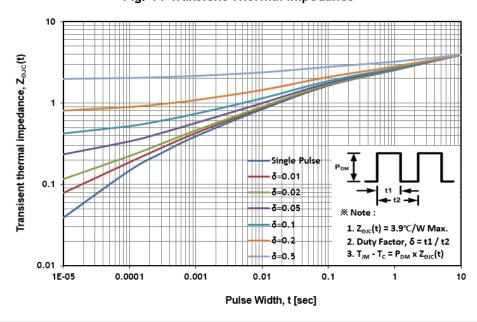
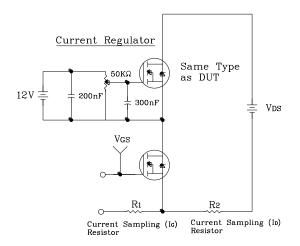


Fig. 11 Transient Thermal Impedance



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Fig. 12 Gate Charge Test Circuit & Waveform



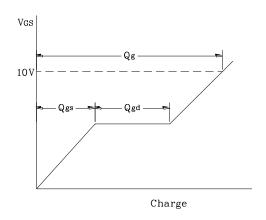
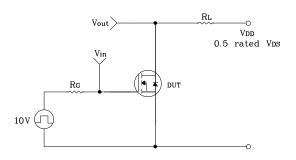


Fig. 13 Resistive Switching Test Circuit & Waveform



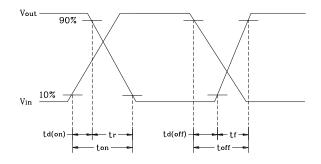


Fig. 14 E_{AS} Test Circuit & Waveform

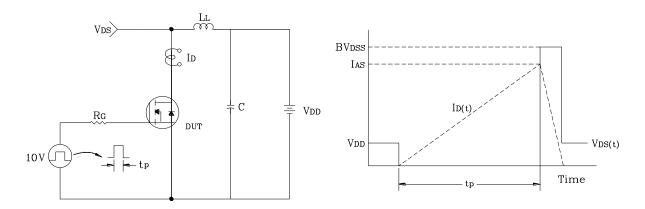
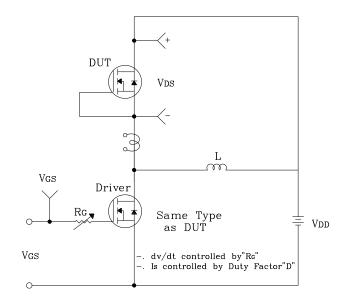
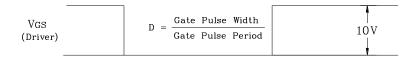
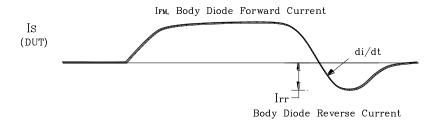
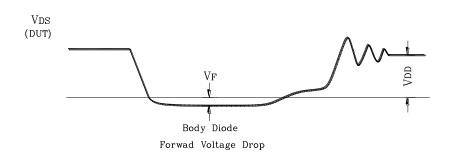


Fig. 15 Diode Reverse Recovery Time Test Circuit & Waveform

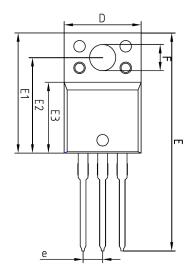


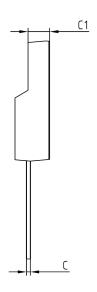


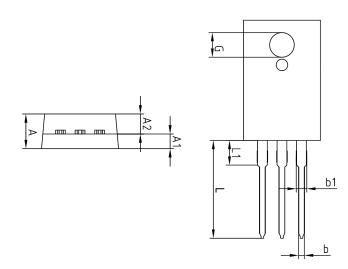




Package Outline Dimensions







| | | NOTE | | |
|--------|---------------|-----------------|---------|------|
| SYMBOL | MINIMUM | NOMINAL | MAXIMUM | NOIE |
| Α | _ | _ | 4.60 | |
| A1 | 2.45 | 2.50 | 2.55 | |
| A2 | 1.95 | 2.00 | 2.05 | |
| Ь | 0.65 | 0.75 | 0.85 | |
| b1 | 1.07 | 1.27 | 1.47 | |
| С | 0.40 | 0.50 | 0.60 | |
| C1 | 2.70 | 2.80 | 2.90 | |
| D | 9.90 | 10.00 | 10.10 | |
| E | 28.00 | _ | 28.60 | |
| E1 | 15.50 | 15.60 | 15.70 | |
| E2 | 12.30 | 12.40 | 12.50 | |
| E3 | 9.15 | 9.20 | 9.25 | |
| F | 3.30 | 3.40 | 3.50 | |
| G | 3.10 | 3.20 2.54 BS | 3.30 | |
| е | | | | |
| L | 12.40 - 13.00 | | | |
| 11 | | | | |

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